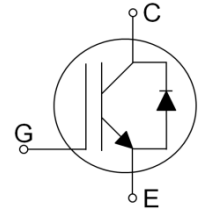


Features

- 1200V Field Stop Trench IGBT Technology
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy Parallel Operation
- Short Circuit Withstanding Time 5μs
- RoHS Compliant
- JEDEC Qualification

TO-247 PLUS



Applications

Inverter, Solar, UPS, Welder

Device	Package	Marking	Remark
TGHP75N120FDR	TO-247 PLUS	TGHP75N120FDR	RoHS

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CES}	1200	V
Gate-Emitter Voltage	V_{GES}	±25	V
Continuous Collector Current	$T_C = 25\text{ }^{\circ}\text{C}$	150	A
	$T_C = 100\text{ }^{\circ}\text{C}$	75	A
Pulsed Collector Current	I_{CM}	300	A
Diode Continuous Forward Current	$T_C = 100\text{ }^{\circ}\text{C}$	75	A
Diode Pulsed Current (Note 1)	I_{FM}	300	A
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	883	W
	$T_C = 100\text{ }^{\circ}\text{C}$	441	W
Operating Junction Temperature	T_{vj}	-55 ~ 175	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 ~ 150	$^{\circ}\text{C}$
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	$^{\circ}\text{C}$

Notes :

(1) Repetitive rating : Pulse width limited by maximum junction temperature.

Thermal Characteristics

Parameter	Symbol	Value	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.17	$^{\circ}\text{C/W}$
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$ (DIODE)	0.34	$^{\circ}\text{C/W}$
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	40	$^{\circ}\text{C/W}$

Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
OFF						
Collector – Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0V, I _C = 1mA	1200	--	--	V
Zero Gate Voltage Collector Current	I _{CES}	V _{CE} = 1200V, V _{GE} = 0V	--	--	1	mA
Gate – Emitter Leakage Current	I _{GES}	V _{CE} = 0V, V _{GE} = ± 25V	--	--	± 500	nA
Integrated Gate Resistance	R _{G(int)}	f = 1MHz, Open Collector	--	2.5	--	Ω
ON						
Gate – Emitter Threshold Voltage	V _{GE(TH)}	V _{GE} = V _{CE} , I _C = 75mA	4.7	6.2	7.7	V
Collector – Emitter Saturation Voltage	V _{CE(SAT)}	V _{GE} = 15V, I _C = 75A, T _{vj} = 25 °C	--	1.70	2.20	V
		V _{GE} = 15V, I _C = 75A, T _{vj} = 125 °C	--	2.05	--	V
		V _{GE} = 15V, I _C = 75A, T _{vj} = 175 °C	--	2.25	--	V
DYNAMIC						
Input Capacitance	C _{IES}	V _{CE} = 30V V _{GE} = 0V f = 1MHz	--	7610	--	pF
Output Capacitance	C _{OES}		--	249	--	pF
Reverse Transfer Capacitance	C _{RES}		--	67	--	pF
Total Gate Charge	Q _g	V _{CC} = 600V, I _C = 75A V _{GE} = 15V	--	325	488	nC
Gate-Emitter Charge	Q _{ge}		--	43	65	nC
Gate-Collector Charge	Q _{gc}		--	164	248	nC
SWITCHING (Note 3)						
Turn-On Delay Time	t _{d(on)}	V _{CC} = 600V, I _C = 37.5A R _G = 2Ω, V _{GE} = 15V Inductive Load, T _{vj} = 25 °C	--	29	--	ns
Rise Time	t _r		--	19	--	ns
Turn-Off Delay Time	t _{d(off)}		--	224	--	ns
Fall Time	t _f		--	63	--	ns
Turn-On Switching Loss	E _{ON}		--	4.43	--	mJ
Turn-Off Switching Loss	E _{OFF}		--	2.07	--	mJ
Total Switching Loss	E _{TS}		--	6.50	--	mJ
Turn-On Delay Time	t _{d(on)}	V _{CC} = 600V, I _C = 75A R _G = 2Ω, V _{GE} = 15V Inductive Load, T _{vj} = 25 °C	--	52	--	ns
Rise Time	t _r		--	76	--	ns
Turn-Off Delay Time	t _{d(off)}		--	174	--	ns
Fall Time	t _f		--	105	--	ns
Turn-On Switching Loss	E _{ON}		--	9.96	14.94	mJ
Turn-Off Switching Loss	E _{OFF}		--	3.76	5.64	mJ
Total Switching Loss	E _{TS}		--	13.72	20.58	mJ

Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
SWITCHING (Note 2)						
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600\text{V}$, $I_C = 37.5\text{A}$ $R_G = 2\Omega$, $V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 175^{\circ}\text{C}$	--	46	--	ns
Rise Time	t_r		--	20	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	306	--	ns
Fall Time	t_f		--	178	--	ns
Turn-On Switching Loss	E_{ON}		--	5.18	--	mJ
Turn-Off Switching Loss	E_{OFF}		--	3.97	--	mJ
Total Switching Loss	E_{TS}		--	9.15	--	mJ
Turn-On Delay Time	$t_{d(on)}$	$V_{CC} = 600\text{V}$, $I_C = 75\text{A}$ $R_G = 2\Omega$, $V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 175^{\circ}\text{C}$	--	49	--	ns
Rise Time	t_r		--	81	--	ns
Turn-Off Delay Time	$t_{d(off)}$		--	235	--	ns
Fall Time	t_f		--	241	--	ns
Turn-On Switching Loss	E_{ON}		--	14.30	21.45	mJ
Turn-Off Switching Loss	E_{OFF}		--	6.82	10.23	mJ
Total Switching Loss	E_{TS}		--	21.12	31.68	mJ
Short Circuit Withstanding Time	t_{SC}	$V_{CC} = 600\text{V}$, $V_{GE} = 15\text{V}$, $T_{vj} = 175^{\circ}\text{C}$	5	--	--	μs

Notes :

(2) Not subject to production test – verified by design/characterization

Electrical Characteristics of the DIODE $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
Diode Forward Voltage	V_{FM}	$I_F = 37.5\text{A}, T_{vj} = 25^{\circ}\text{C}$	--	1.40	--	V
		$I_F = 37.5\text{A}, T_{vj} = 125^{\circ}\text{C}$	--	1.37	--	V
		$I_F = 37.5\text{A}, T_{vj} = 175^{\circ}\text{C}$	--	1.36	--	V
		$I_F = 75\text{A}, T_{vj} = 25^{\circ}\text{C}$	--	1.70	--	V
		$I_F = 75\text{A}, T_{vj} = 125^{\circ}\text{C}$	--	1.74	--	V
		$I_F = 75\text{A}, T_{vj} = 175^{\circ}\text{C}$	--	1.78	--	V
Reverse Recovery Time	t_{rr}	$I_F = 37.5\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$	--	252	--	ns
Reverse Recovery Current	I_{rr}		--	19.1	--	A
Reverse Recovery Charge	Q_{rr}		--	1.16	--	μC
Reverse Recovery Time	t_{rr}	$I_F = 37.5\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 175^{\circ}\text{C}$	--	422	--	ns
Reverse Recovery Current	I_{rr}		--	35.0	--	A
Reverse Recovery Charge	Q_{rr}		--	10.30	--	μC
Reverse Recovery Time	t_{rr}	$I_F = 75\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$	--	359	--	ns
Reverse Recovery Current	I_{rr}		--	22.0	--	A
Reverse Recovery Charge	Q_{rr}		--	4.98	--	μC
Reverse Recovery Time	t_{rr}	$I_F = 75\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 175^{\circ}\text{C}$	--	548	--	ns
Reverse Recovery Current	I_{rr}		--	35.8	--	A
Reverse Recovery Charge	Q_{rr}		--	12.70	--	μC

IGBT Characteristics

Fig. 1 IGBT Output Characteristics

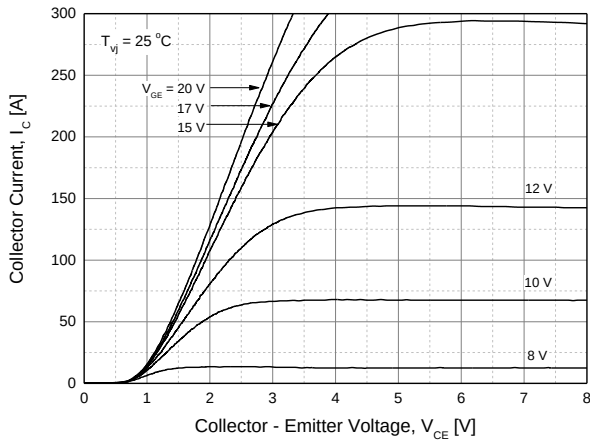


Fig. 2 IGBT Output Characteristics

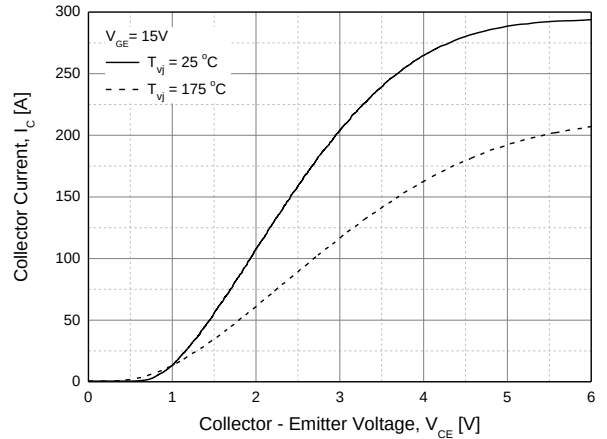


Fig. 3 IGBT Saturation Voltage vs. Junction Temperature

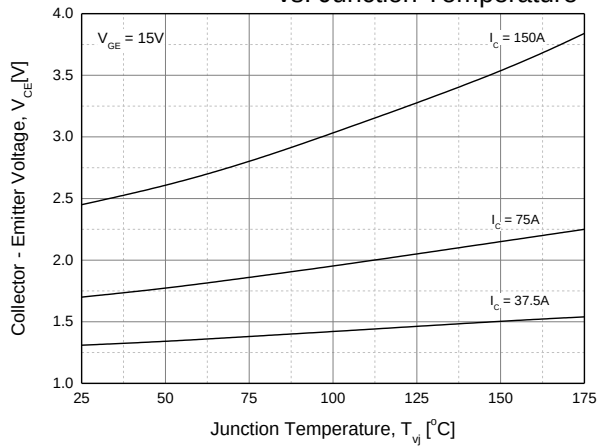


Fig. 4 IGBT Saturation Voltage vs. Gate Bias

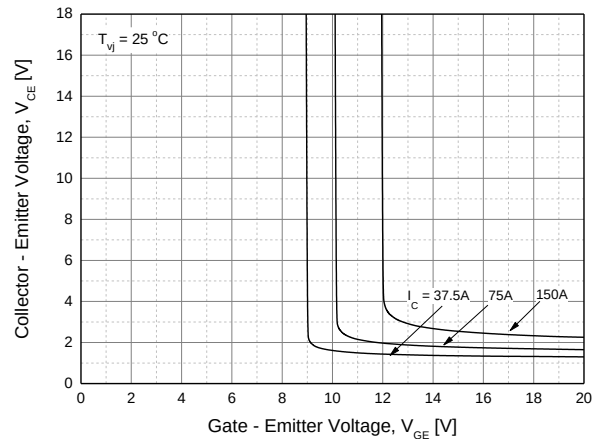


Fig. 5 IGBT Saturation Voltage vs. Gate Bias

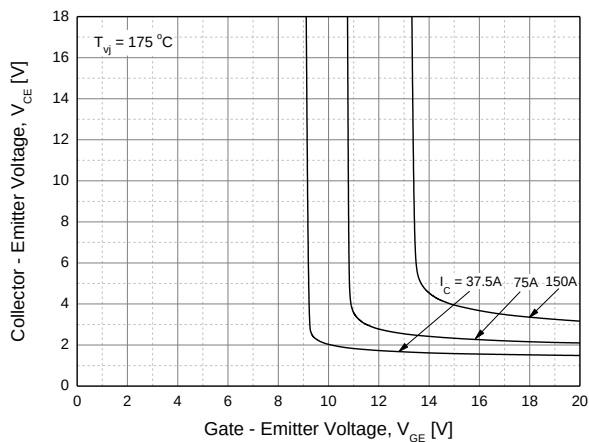
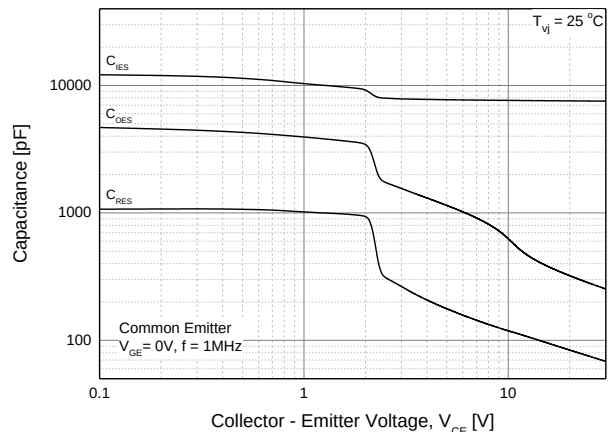


Fig. 6 IGBT Capacitance Characteristics



IGBT Characteristics

Fig. 7 Turn-on Time vs. Gate Resistor

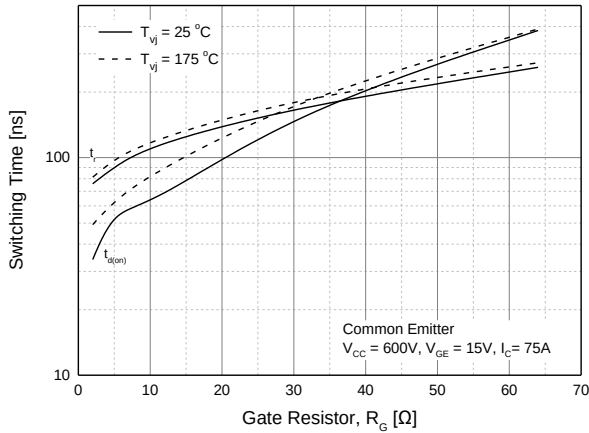


Fig. 8 Turn-off Time vs. Gate Resistor

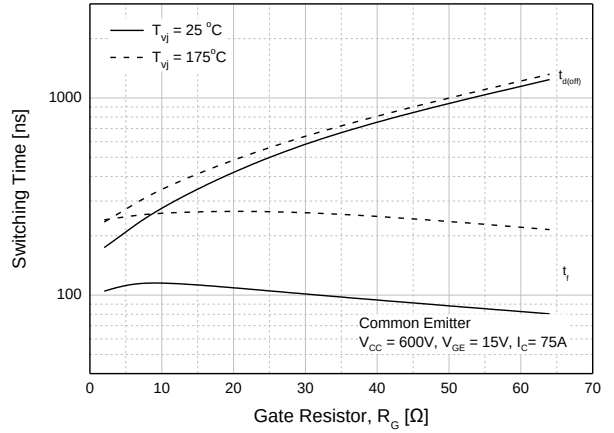


Fig. 9 Switching Loss vs. Gate Resistor

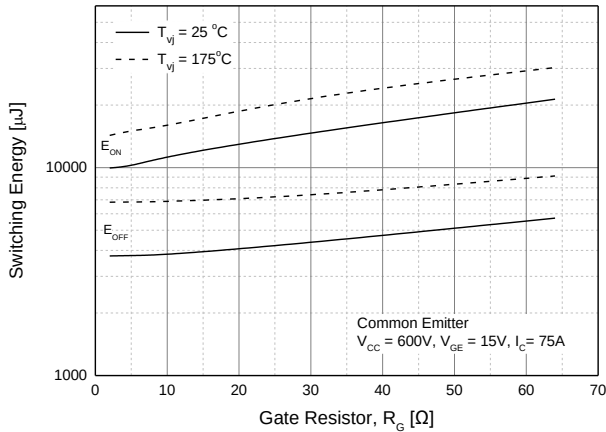


Fig. 10 Turn-on Time vs. Collector Current

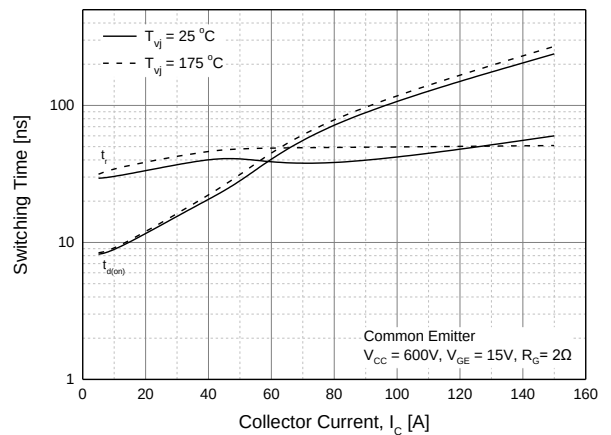


Fig. 11 Turn-off Time vs. Collector Current

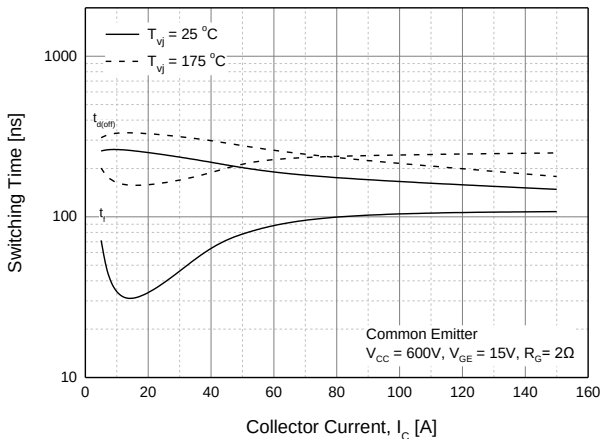
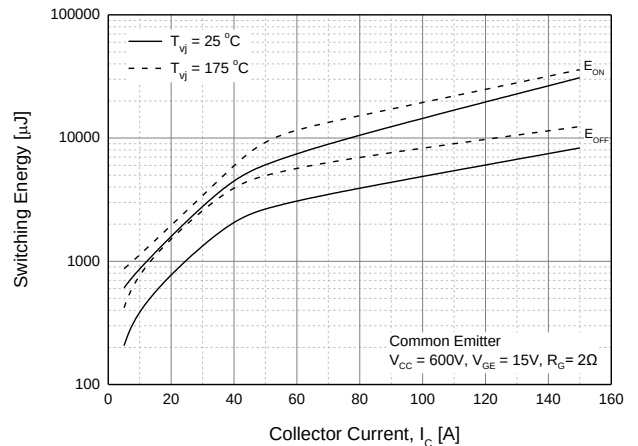


Fig. 12 Switching Loss vs. Collector Current



IGBT Characteristics

Fig. 13 Gate Charge Characteristics

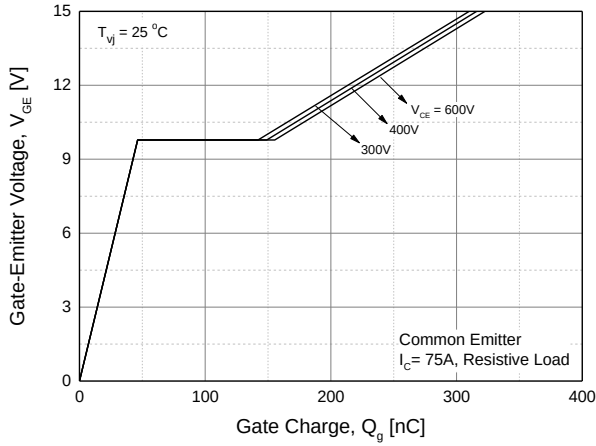


Fig. 14 SOA

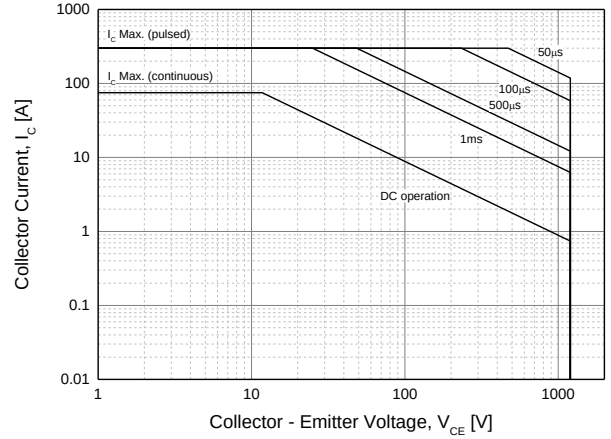


Fig. 15 RBSOA

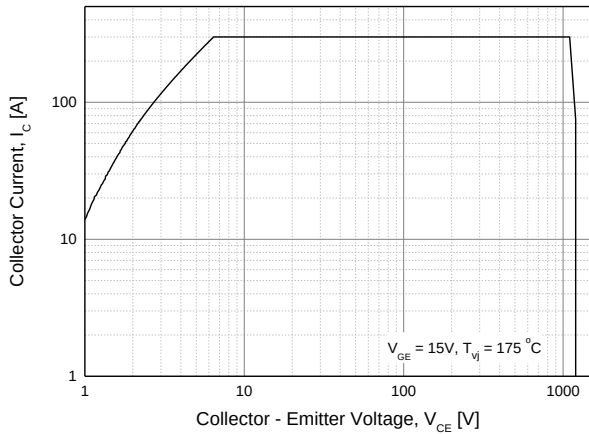


Fig. 16 Transient Thermal Impedance of IGBT

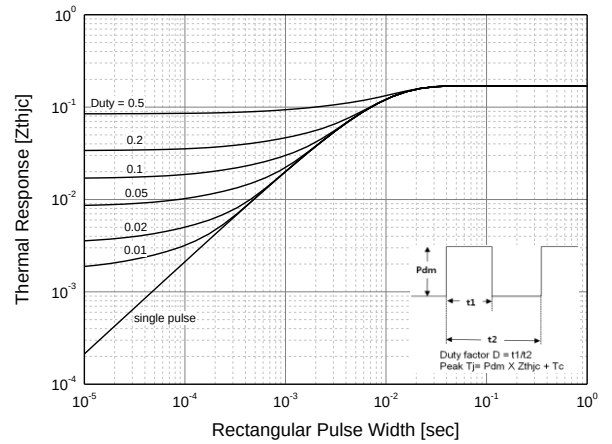
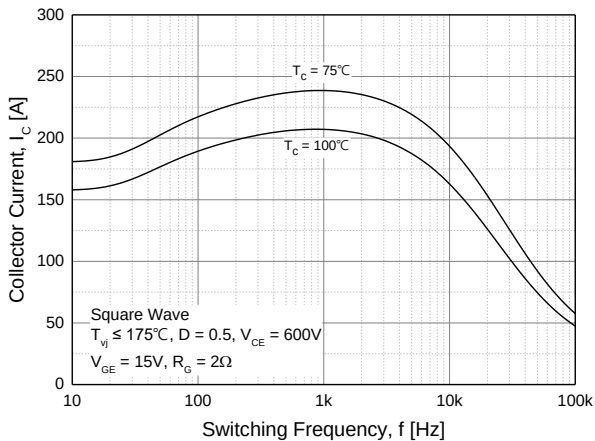


Fig. 17 Load Current vs. Frequency



DIODE Characteristics

Fig. 18 Diode Conduction Characteristics

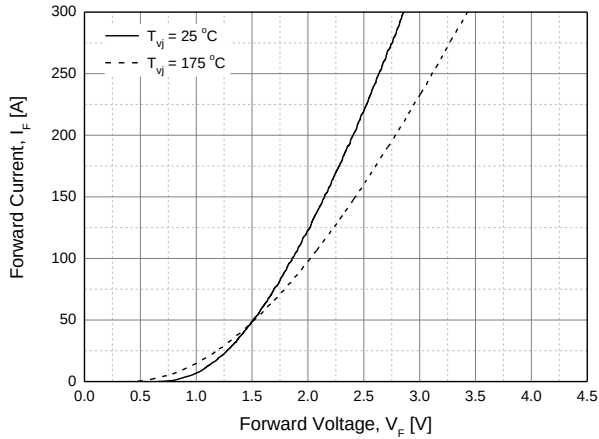


Fig. 19 Reverse Recovery Current vs. Forward Current

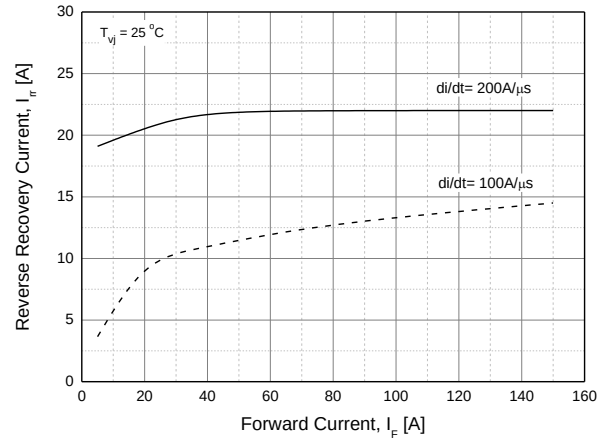


Fig. 20 Reverse Recovery Charge vs. Forward Current

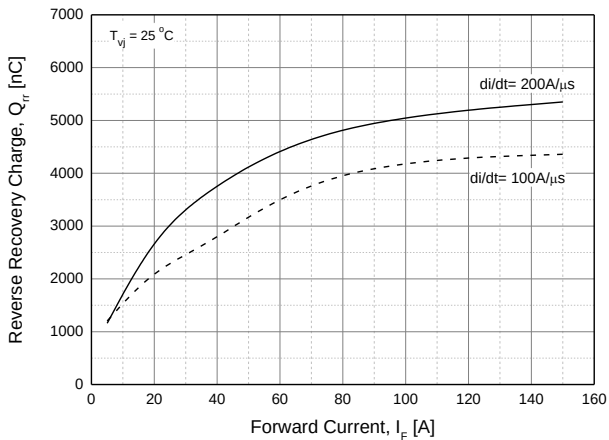
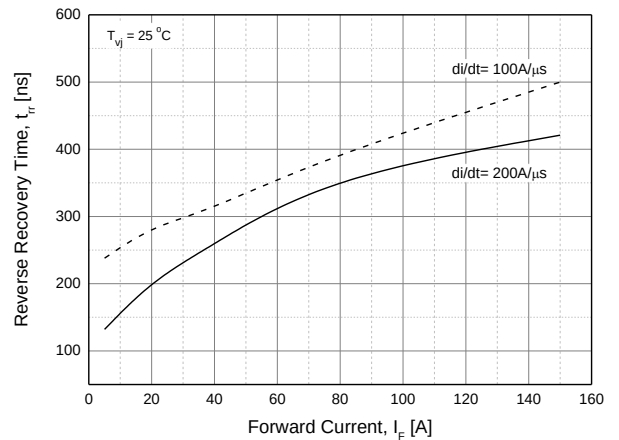
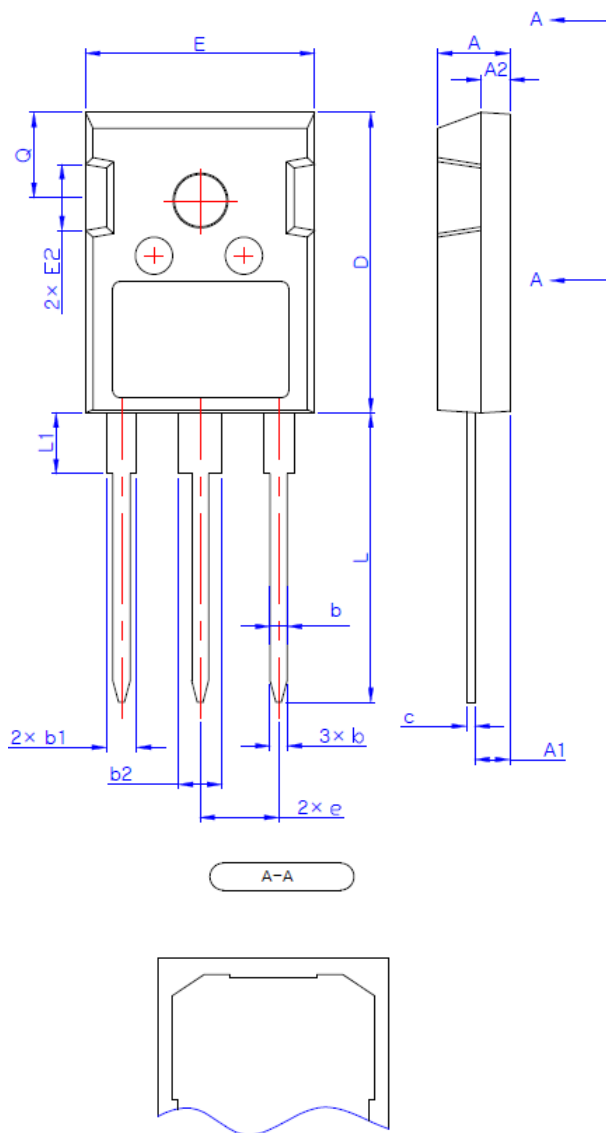


Fig. 21 Reverse Recovery Time vs. Forward Current



TO-247 PLUS MECHANICAL DATA


SYMBOL	MIN	MAX
A	4,80	5,20
A1	2,29	2,54
A2	1,90	2,10
b	1,10	1,30
b1	2,00	2,20
b2	3,00	3,20
c	0,50	0,70
D	20,80	21,34
E	15,75	16,13
E2	4,32	4,83
e	5,45 BSC	
L	19,85	20,25
L1	-	4,49
Q	5,59	6,19

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